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Two-dimensional simulation of an inductively coupled plasma discharge of Ar/O<sub>2</sub> including heat transfer, gas flow, and EEDF

Donggil Kim<sup>1</sup>, EunHee Choi<sup>1</sup>, YeJin Shon<sup>1</sup>, Deuk-Chul Kwon<sup>2</sup>, Jea-Hong Jeon<sup>1</sup>, and HeeHwan Choe<sup>1</sup>

<sup>1</sup>Korea Aerospace Univ., Korea, Republic of

<sup>2</sup>National Fusion Research Institute, Korea, Republic of

Assuming azimuthal symmetry, an inductively coupled plasma (ICP) discharge based on a fluid model is investigated by coupling multiple physics simultaneously. In this simulation model, Ar/O<sub>2</sub> plasma discharge is considered including heat transfer and gas flow. Since the electron energy distribution function (EEDF) is one of the important factors which determine the plasma discharge properties, two-term Boltzmann approximation is applied to obtain EEDF. Using this EEDF, the plasma discharge is calculated iteratively until the EEDF and the plasma parameters are converged. Although the method of obtaining EEDF is based on global parameters, it gives important information on how the plasma parameters are related. Also, the heat transfer and the gas flow are considered to investigate the relations and effects of temperature and pressure profiles to the plasma parameters. In case of gas mixture, the partial pressure profiles of gas will be changed by process conditions which affect plasma discharge, that the profiles of temperature and pressure is solved to resolve these effects. Therefore, the EEDF will be modified considering heat transfer and gas flow. In this research, the EEDF, temperature and partial pressure profiles are obtained for different Ar/O<sub>2</sub> ratio. Finally, the ion energy distribution function (IEDF) on the substrate is calculated using particle model considering all physical parameters to analyze complex relationship between process and plasma parameters.

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